SUP90N04-3m3P

Vishay Siliconix



| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
|---|----------------------|---|------|--------|--------|------|--|
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{DS} = 0 V$, $I_{D} = 250 \mu A$ | 40 | | | v | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \ \mu A$ | 1 | | 2.5 | v | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 20 V$ | | | ± 250 | nA | |
| | I _{DSS} | $V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$ | | | 1 | μΑ | |
| Zero Gate Voltage Drain Current | | V_{DS} = 40 V, V_{GS} = 0 V, T_{J} = 125 °C | | | 50 | | |
| | | $V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 150 ^{\circ}\text{C}$ | | | 250 | | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 10$ V, $V_{GS} = 10$ V | 50 | | | Α | |
| | D | V _{GS} = 10 V, I _D = 22 A | | 0.0027 | 0.0033 | Ω | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | $V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$ | | 0.0034 | 0.0041 | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = 15 V, I _D = 20 A | | 169 | | S | |
| Dynamic ^b | • | | • | • | | | |
| Input Capacitance | C _{iss} | | | 5286 | | pF | |
| Output Capacitance | C _{oss} | $V_{GS} = 0 V, V_{DS} = 20 V, f = 1 MHz$ | | 705 | | | |
| Reverse Transfer Capacitance | C _{rss} | | | 283 | | | |
| Total Gate Charge ^c | Qg | | | 87 | 131 | nC | |
| Gate-Source Charge ^c | Q _{gs} | $V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 20 \text{ A}$ | | 15.3 | | | |
| Gate-Drain Charge ^c | Q _{gd} | | | 12.2 | | | |
| Gate Resistance | Rg | f = 1 MHz | 0.5 | 2.7 | 5.4 | Ω | |
| Turn-On Delay Time ^c | t _{d(on)} | | | 11 | 20 | | |
| Rise Time ^c | t _r | | | 7 | 14 | - | |
| Turn-Off Delay Time ^c | t _{d(off)} | | 45 | 68 | ns | | |
| Fall Time ^c | t _f | | | 7 | 14 | | |
| Drain-Source Body Diode Ratings an | nd Characteris | stics T _C = 25 °C ^b | | | | | |
| Continuous Current | ا _S | | | | 90 | _ | |
| Pulsed Current | I _{SM} | | | | 160 | A | |
| Forward Voltage ^a | V _{SD} | $I_{F} = 10 \text{ A}, V_{GS} = 0 \text{ V}$ | | 0.72 | 1.2 | V | |
| Reverse Recovery Time | t _{rr} | | | 42 | 63 | ns | |
| Peak Reverse Recovery Current | I _{RM(REC)} | I _F = 10 A, dl/dt = 100 A/μs | | 2.5 | 3.8 | Α | |
| Reverse Recovery Charge | Q _{rr} | | | 52 | 78 | nC | |

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

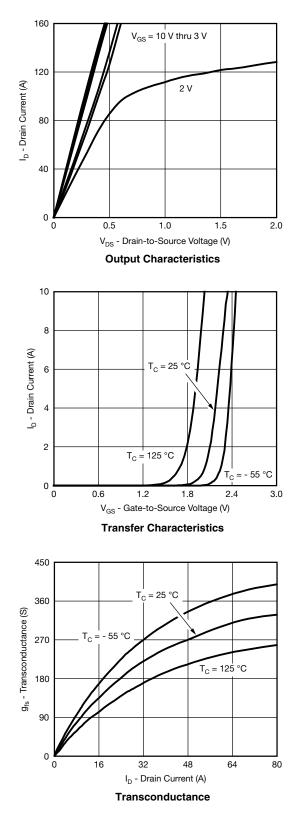
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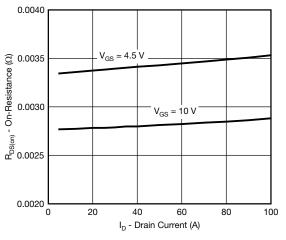


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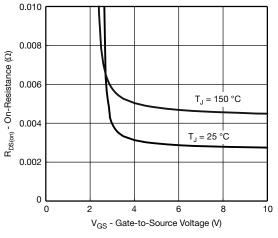
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

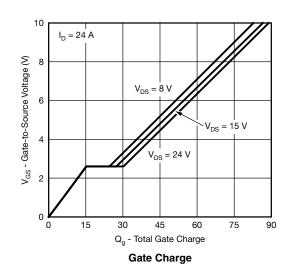




On-Resistance vs. Drain Current





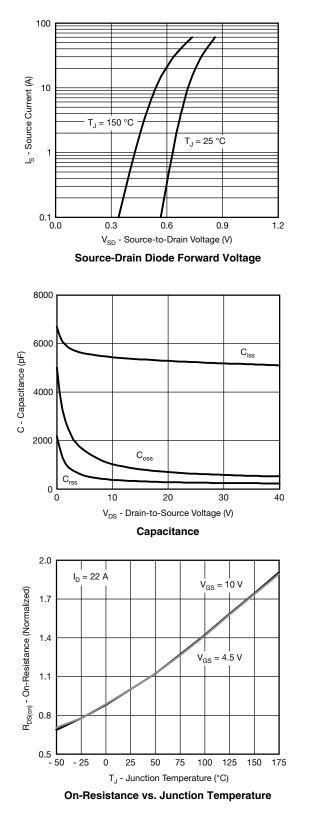


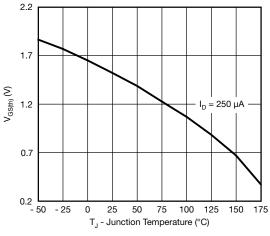
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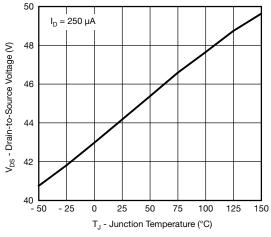
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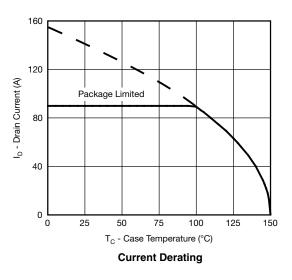




Threshold Voltage



Drain Source Breakdown vs. Junction Temperature



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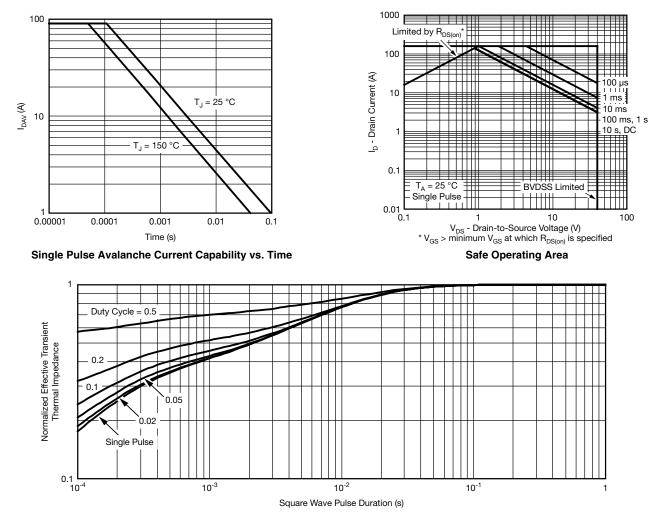
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Normalized Thermal Transient Impedance, Junction-to-Case

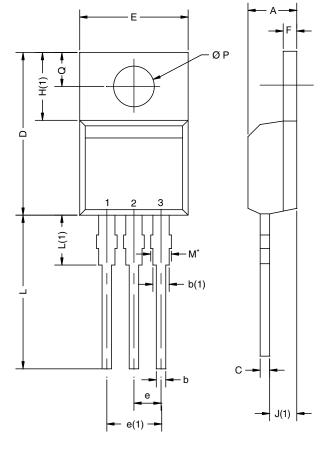
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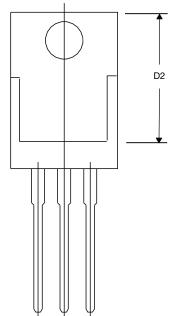
TO-220AB



| | MILLIN | IETERS | INCHES | | |
|-----------------------|-------------------|-----------|--------|-------|--|
| DIM. | MIN. | MAX. | MIN. | MAX. | |
| А | 4.25 | 4.65 | 0.167 | 0.183 | |
| b | 0.69 | 1.01 | 0.027 | 0.040 | |
| b(1) | 1.20 | 1.73 | 0.047 | 0.068 | |
| С | 0.36 | 0.61 | 0.014 | 0.024 | |
| D | 14.85 | 15.49 | 0.585 | 0.610 | |
| D2 | 12.19 | 12.70 | 0.480 | 0.500 | |
| Е | 10.04 | 10.51 | 0.395 | 0.414 | |
| е | 2.41 | 2.67 | 0.095 | 0.105 | |
| e(1) | 4.88 | 5.28 | 0.192 | 0.208 | |
| F | 1.14 | 1.40 | 0.045 | 0.055 | |
| H(1) | 6.09 | 6.48 | 0.240 | 0.255 | |
| J(1) | 2.41 | 2.92 | 0.095 | 0.115 | |
| L | 13.35 | 14.02 | 0.526 | 0.552 | |
| L(1) | 3.32 | 3.82 | 0.131 | 0.150 | |
| ØΡ | 3.54 | 3.94 | 0.139 | 0.155 | |
| Q | 2.60 | 3.00 | 0.102 | 0.118 | |
| ECN: T14- DWG: 547 | 0413-Rev. P, 1 | 16-Jun-14 | | | |

Note

 * M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



Revison: 16-Jun-14

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